

APPROVAL SHEET

WR12, WR08, WR06, WR04

±1%, ±5%

General purpose chip resistors Size 1206, 0805, 0603, 0402

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FEATURE

- 1. High reliability and stability
- 2. Reduced size of final equipment
- 3. Lower assembly costs
- 4. Higher component and equipment reliability
- 5. Lead free products upon customer requested

APPLICATION

- · Consumer electrical equipment
- Automotive application
- EDP, Computer application
- Telecom application

DESCRIPTION

The resistors are constructed in a high grade ceramic body (aluminum oxide). Internal metal electrodes are added at each end and connected by a resistive paste that is applied to the top surface of the substrate. The composition of the paste is adjusted to give the approximate resistance required and the value is trimmed to within tolerance by laser cutting of this resistive layer.

The resistive layer is covered with a protective coat. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end terminations is a Tin (lead free) alloy.

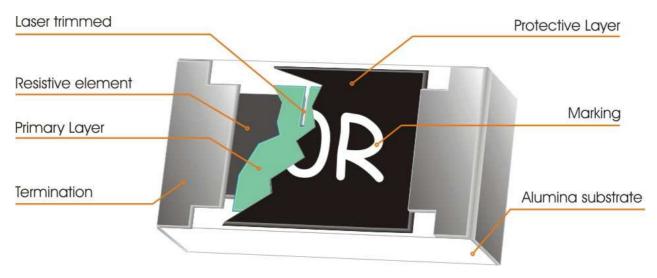


Fig 1. Consctruction of a Chip-R



QUICK REFERENCE DATA

Item		General Specification						
Series No.	WF	R12	WF	R08	WR06		WR04	
Size code	1206(3216)	0805(2012)	0603(1608)	0402(1005)	
Resistance Range		1Ω~1	0MΩ(±5% to	olerance),100	2~1MΩ(±1%	tolerance),	Jumper	
Resistance	±1%	±5%	±1%	±5%	±1%	±5%	±1%	±5%
Tolerance	E96/E24	E24	E96/E24	E24	E96/E24	E24	E96/E24	E24
TCR (ppm/°C)								
R≥1MΩ		≤ ± 200		≤ ± 200		≤ ± 200		-300~+500
$1M\Omega > R > 10\Omega$	≤± 100	≤ ± 200	≤ ± 100	≤ ± 200	≤± 100	≤± 200	≤ ± 100	≤ ± 200
R≤10Ω		-300~+500		-300~+500		-300~+500		-300~+500
Max. dissipation @ T _{amb} =70°C	1/4	W	1/8 W		1/10 W		1/16 W	
Max. Operation Voltage (DC or RMS)	200V		150V		50V		50V	
Max. Overload Voltage (DC or RMS)	400V		300V		100V		100V	
Climatic category				55/1	55/56			

Note:

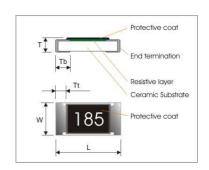
- 1. This is the maximum voltage that may be continuously supplied to the resistor element, see "IEC publication 60115-8"
- 2. Max. Operation Voltage : So called RCWV (Rated Continuous Working Voltage) is determined by

 $RCWV = \sqrt{RatedPower \times Resistance Value}$ or Max. RCWV listed above, whichever is lower.

- 3. The resistance range 1~10 Ω and 1M ~10M Ω with 1% tolerance please refer to WR12W / WR08W / WR06W series.
- 4. The resistance of Jumper is defined $< 0.05\Omega$.

DIMENSIONS (unit: mm)

	WR12	WR08	WR06	WR04
L	3.10 ± 0.10	2.00 ± 0.10	1.60 ± 0.10	1.00 ± 0.05
W	1.60 ± 0.10	1.25 ± 0.10	0.80 ± 0.10	0.50 ± 0.05
Т	0.60 ± 0.15	0.50 ± 0.15	0.45 ± 0.15	0.35 ± 0.05
Tb	0.45 ± 0.20	0.40 ± 0.20	0.30 ± 0.15	0.25 ± 0.10
Tt	0.50 ± 0.20	0.40 ± 0.20	0.30 ± 0.10	0.20 ± 0.10



MARKING



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Size \ Nr. Of digit of code\tolerance	±5%	±1%		
1206 (3216)	3-digits marking	4-digits marking		
0805 (2012)	3-digits marking	4-digits marking		
0603 (1608)	3-digits marking	3-digits marking		
0402(1005)	N0 MARKING			

3-digits marking (±5%: 1206 & 0805 & 0603)

Each resistor is marked with a three digits code on the protective coating to designate the nominal resistance value. For values up to 9.1 the R is used as a decimal point. For values of 10.0 or greater the first 2 digits apply to the resistance value and third indicate the number of zeros to follow.

3-digits marking (\pm 1%: 0603)

Nominal	l resistan	се							Descr	iption					
1.E-24 s	series		·	As <i>0603</i>	s 0603 WR06X ±5%.										
2.E-96 s	series			The 1st t	wo digit o	codes ar	e referrin	g to the	CODE or	the tab	le, the 3r	d code is	s the inde	x of resi	stance
				Y=10 ⁻² ,	X=10 ⁻¹ ,	A=10 ⁰ ,	B=10 ¹ ,	C=10 ² ,	D=10 ³ ,	E=10 ⁴ ,	F=10 ⁵				
						EX:	17.8 Ω=	25X,17	8Ω=25A	, 1K78	=25B				
							17K8=2	25C · 17	'8K=25D	, 1M78	=25E				
3. Rema	ark			There is	no marki	ng for th	e items a	re not u	nder E-24	and E-9	96 series				
CODE	R_value	CODE	R_value	CODE	R_Value	CODE	R_value	CODE	R_value	CODE	R_value	CODE	R_value	CODE	R_value
01	100	13	133	25	178	37	237	49	316	61	422	73	562	85	750
02	102	14	137	26	182	38	243	50	324	62	432	74	576	86	768
03	105	15	140	27	187	39	249	51	332	63	442	75	590	87	787
04	107	16	143	28	191	40	255	52	340	64	453	76	604	88	806
05	110	17	147	29	196	41	261	53	348	65	464	77	619	89	825
06	113	18	150	30	200	42	267	54	357	66	475	78	634	90	845
07	115	19	154	31	205	43	274	55	365	67	487	79	649	91	866
08	118	20	158	32	210	44	280	56	374	68	499	80	665	92	887
09	121	21	162	33	215	45	287	57	383	69	511	81	681	93	909
10	124	22	165	34	34 221 46 294 58 392 70 523 82 698 94						94	931			
11	127	23	169	35	226	47	301	59	402	71	536	83	715	95	953
12	130	24	174	36	232	48	309	60	412	72	549	84	732	96	976



4-digits marking (±1%: 1206/0805)

Each resistor is marked with a four digits code on the protective coating to designate the nominal resistance value. For values of $<97.6\Omega$ the R is used as a decimal point. For values of 100Ω or greater the first 3 digits are significant, the fourth indicates the number of zeros to follow.

Example

RESISTANCE	10Ω	12Ω	100Ω	6800Ω	47000Ω
3-digits marking (1206 & 0805 & 0603 ±5%)	100	120	101	682	473
4-digits marking	10R0	12R0	1000	6801	4702

FUNCTIONAL DESCRIPTION

Product characterization

Standard values of nominal resistance are taken from the E24 series for resistors with a tolerance of $\pm 5\%$, and E96 series for resistors with a tolerance of $\pm 1\%$. The values of the E24/E96 series are in accordance with "IEC publication 60063"

Derating

The power that the resistor can dissipate depends on the operating temperature; see Fig.2

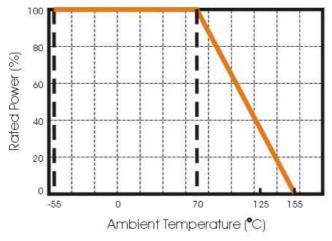


Figure 2 Maximum dissipation in percentage of rated power as a function of the ambient temperature for WR12X WR08X, WR06X, WR04X

MOUNTING

Due to their rectangular shapes and small tolerances, Surface Mountable Resistors are suitable for handling by automatic placement systems.

Chip placement can be on ceramic substrates and printed-circuit boards (PCBs).

Electrical connection to the circuit is by individual soldering condition.

The end terminations guarantee a reliable contact.



SOLDERING CONDITION

The robust construction of chip resistors allows them to be completely immersed in a solder bath of 260°C for 10 seconds. Therefore, it is possible to mount Surface Mount Resistors on one side of a PCB and other discrete components on the reverse (mixed PCBs).

Surface Mount Resistors are tested for solderability at 245°C during 3 seconds. The test condition for no leaching is 260°C for 30 seconds. Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 3.

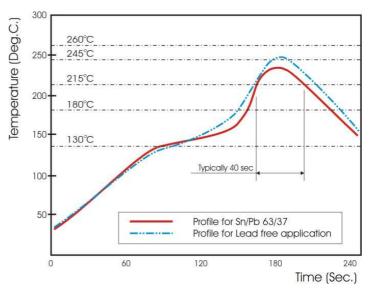


Fig 3. Infrared soldering profile for Chip Resistors

CATALOGUE NUMBERS

The resistors have a catalogue number starting with .

WR12	Х	472_	J	Т	L
Size code	Type code	Resistance code	Tolerance	Packaging code	Termination
WR12 : 1206 WR08 : 0805	X : Normal	E24 : 2 significant digits followed by no. of zeros and a blank 4.7Ω =4R7_	F:±1% J:±5%	T: 7" Reeled taping Q: 10" Reeled taping	L = Sn base (lead free)
WR06 : 0603 WR04: 0402		10Ω =100_ 220Ω =221_ Jumper =000_ ("_" means a blank)	P : Jumper	G: 13" Reeled taping B: Bulk	
		E96 : 3 significant digits followed by no. of zeros $102\Omega = 1020$ $37.4K\Omega = 3742$			

WR12,WR08,WR06:

1. Reeled tape packaging: 8mm width paper taping 5000pcs per 7" reel, 10kpcs per 10" reel, 20kpcs per 13" reel.

2. Bulk packaging : 5000pcs per poly-bag

WR04:

1. Reeled tape packaging: 8mm width paper taping 10,000pcs per reel,

2. Bulk packaging : 10,000pcs per poly-bag



TEST AND REQUIREMENTS(JIS C 5201-1 : 1998)

Essentially all tests are carried out according to the schedule of IEC publication 115-8, category LCT/UCT/56(rated temperature range: Lower Category Temperature, Upper Category Temperature; damp heat, long term, 56 days). The testing also meets the requirements specified by EIA, EIAJ and JIS.

The tests are carried out in accordance with IEC publication 68, "Recommended basic climatic and mechanical robustness testing procedure for electronic components" and under standard atmospheric conditions according to IEC 60068-1, subclause 5.3. Unless otherwise specified, the following value supplied:

Temperature: 15°C to 35°C. Relative humidity: 45% to 75%.

Air pressure: 86kPa to 106 kPa (860 mbar to 1060 mbar). All soldering tests are performed with midly activated flux.

TEST	PROCEDURE / TEST METHOD	REQUIREMENT			
TEST	PROCEDURE / TEST METHOD	Resistor	0Ω		
DC resistance	DC resistance values measured at the test voltages specified below :				
Clause 4.5	<10 Ω @0.1V, <100 Ω @0.3V, <1K Ω @1.0V,	Within the specified tolerance	$<$ 50m Ω		
	<10KΩ@3V, <100KΩ@10V, <1MΩ@25V, <10MΩ@30V				
Temperature	Natural resistance change per change in degree centigrade.				
Coefficient of Resistance(T.C.R)	$R_2 - R_1 \times 10^6 (\text{ppm}/\text{gC})$	Refer to			
Clause 4.8	$\frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6 \text{ (ppm/°C)} t_1 : 20\text{°C} + 5\text{°C} - 1\text{°C}$	"QUICK REFERENCE DATA"	N/a		
	R ₁ : Resistance at reference temperature				
	R ₂ : Resistance at test temperature				
Short time overload (S.T.O.L)	Permanent resistance change after a 5second application of a voltage 2.5 times RCWV or the maximum overload voltage specified in the	Δ R/R max. \pm (2%+0.10 Ω)	<50mΩ		
Clause 4.13	above list, whichever is less.				
Resistance to soldering heat(R.S.H) IEC 60068-2-58:2004	Un-mounted chips completely immersed for 10±1second in a SAC solder bath at 255°C ±5°C	Δ R/R max. \pm (1%+0.05 Ω) no visible damage	<50mΩ		
Solderability	Un-mounted chips completely immersed for 3±0.3 second in a SAC	95% coverage min., good tinning and no			
IEC 60068-2-58:2004	solder bath at 245°C ±5°C	visible damage			
Temperature cycling	30 minutes at -55°C±3°C, 2~3 minutes at 20℃+5℃-1℃, 30 minutes at	Δ R/R max. ±(1%+0.05Ω)	<50mΩ		
Clause 4.19	+155°C±3°C, 2~3 minutes at 20℃+5℃-1℃, total 5 continuous cycles	,			
Damp Heat	1000 +48/-0 hours, loaded with RCWV or Vmax in humidity chamber	10Ω≤R<1MΩ :			
(Load life in humidity)	controller at 40°C±2°C and 90~95% relative humidity, 1.5hours on and	Δ R/R max. \pm (3%+0.10 Ω)	<50m Ω		
Clause 4.24	0.5 hours off	R<10Ω, R≥1MΩ : ΔR/R max. ±(5%+0.10Ω)			
Load Life(Endurance)	1000 +48/-0 hours; loaded with RCWV or V _{max} in chamber controller	Ditto.	1		
Clause 4.25	70±2°C, 1.5 hours on and 0.5 hours off	Ditto.			
Bending strength	Resistors mounted on a 90mm glass epoxy resin PCB(FR4), bending	No visual damaged,			
Clause 4.33	once 3mm for 10sec, 5mm for WR04	Δ R/R max. \pm (1%+0.05 Ω)	<50mΩ		
Adhesion	Pressurizing force: 5N, Test time: 10±1sec.	No remarkable damage or re	moval of		
Clause 4.32		the terminations			



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TEST	PROCEDURE / TEST METHOD	REQUIREMENT			
	PROCEDURE / TEST METHOD	Resistor	0Ω		
Insulation	Apply the maximum overload voltage (DC) for 1minute	R≥10GΩ			
Resistance					
JISC5201-1:1998					
Clause 4.6					
Dielectric Withstand	Apply the maximum overload voltage (AC) for 1 minute	No breakdown or flashover			
Voltage					
JISC5201-1:1998					
Clause 4.7					

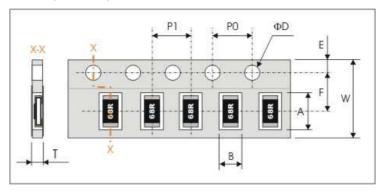
TEST CONDITION FOR JUMPER (0 $\Omega)$

Item	WR12	WR08	WR06	WR04	
Power Rating At 70°C	1/4W 1/8W 1/10W		1/10W	1/16W	
Resistance	MAX.50mΩ				
Rated Current	2A	1.5A	1A	1A	
Peak Current	5A	3.5A	3A	1.5A	
Operating Temperature	-55~155°C				



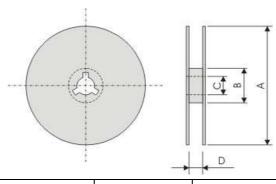
PACKAGING

Paper Tape specifications (unit :mm)



Series No.	Α	В	W	F	E
WR12	3.60±0.20	2.00±0.20			
WR08	2.40±0.20	1.65±0.20	8.00±0.30	3.50±0.20	1.75±0.10
WR06	1.90±0.20	1.10±0.20			3.30±0.20
WR04	1.20±0.10	0.70±0.10			
Series No.	P1	P0	ΦD	T	
WR12 / WR08	400.040			Max. 1.0	
WR06	4.00±0.10	4.00±0.10	Φ 1.50 $^{+0.1}_{-0.0}$	0.65±0.05	
WR04	2.00±0.10			0.40±0.05	

7" Reel dimensions



Symbol	Α	В	С	D
(unit : mm)	Φ178.0±2.0	Φ60.0±1.0	13.0±0.2	9.0±0.5